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ISL9V5036S3S / ISL9V5036P3 / ISL9V5036S3

EcoSPARK® 500mJ, 360V, N-Channel Ignition IGBT

General Description

The ISL9V5036S3S, ISL9V5036P3, and ISL9V5036S3 are the next generation IGBTs that offer outstanding SCIS capability in the D2-Pak (TO-263) and TO-220 plastic package. These devices are intended for use in automotive ignition circuits, specifically as coil drivers. Internal diodes provide voltage clamping without the need for external components.

EcoSPARK® devices can be custom made to specific clamp voltages. Contact your nearest ON Semiconductor sales office for more information.

Formerly Developmental Type 49443

Applications

- · Automotive Ignition Coil Driver Circuits
- · Coil-On Plug Applications

Features

- Industry Standard D²-Pak package
 SCIS Energy = 500mJ at T_J = 25°C
- Logic Level Gate Drive
- · Qualified to AEC Q101
- · RoHS Compliant



Package Symbol COLLECTOR JEDEC TO-262AA JEDEC TO-263AB JEDEC TO-220AB E_CG D2-Pak COLLECTOR COLLECTOR (FLANGE) (FLANGE)

Device Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
BV _{CER}	Collector to Emitter Breakdown Voltage (I _C = 1 mA)	390	V
BV _{ECS}	Emitter to Collector Voltage - Reverse Battery Condition (I _C = 10 mA)	24	V
E _{SCIS25}	At Starting $T_J = 25$ °C, $I_{SCIS} = 38.5$ A, $L = 670 \mu Hy$	500	mJ
E _{SCIS150}	At Starting $T_J = 150$ °C, $I_{SCIS} = 30$ A, $L = 670 \mu$ Hy	300	mJ
I _{C25}	Collector Current Continuous, At T _C = 25°C, See Fig 9	46	Α
I _{C110}	Collector Current Continuous, At T _C = 110°C, See Fig 9	31	Α
V_{GEM}	Gate to Emitter Voltage Continuous	±10	V
P _D	Power Dissipation Total T _C = 25°C	250	W
	Power Dissipation Derating T _C > 25°C	1.67	W/°C
T _J	Operating Junction Temperature Range	-40 to 175	°C
T _{STG}	Storage Junction Temperature Range	-40 to 175	°C
T _L	Max Lead Temp for Soldering (Leads at 1.6mm from Case for 10s)	300	°C
T _{pkg}	Max Lead Temp for Soldering (Package Body for 10s)	260	°C
ESD	Electrostatic Discharge Voltage at 100pF, 1500Ω	4	kV

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Device Marking		king Device		е	Reel Size	Э	Tape Wic	lth	Quantity
V5036S		ISL9V5036S3ST	·	TO-263AB 330mm			24mm		800
V5036P		ISL9V5036P3	TO-220A	TO-220AA Tube			N/A		50
V5036S		ISL9V5036S3	TO-262A	TO-262AA Tube		N/A			50
V50	36S	ISL9V5036S3S	TO-263A	λB	Tube		N/A		50
Electric	al Char	acteristics T _A = 25°	C unless other	wise n	oted				
Symbol Parameter			Tes	Test Conditions			Тур	Max	Units
Off State	Characte	eristics							
BV _{CER}	Collector to Emitter Breakdown Voltage		$R_G = 1K$	$I_C = 2mA$, $V_{GE} = 0$, $R_G = 1K\Omega$, See Fig. 15 $T_J = -40$ to 150°C			360	390	V
BV _{CES}	Collector	Collector to Emitter Breakdown Voltage		$I_C = 10$ mA, $V_{GE} = 0$, $R_G = 0$, See Fig. 15 $T_J = -40$ to 150°C			390	420	V
BV _{ECS}	Emitter to	Collector Breakdown Volta		$I_C = -75 \text{mA}, V_{GE} = 0 \text{V},$ $T_C = 25 ^{\circ} \text{C}$			-	-	V
BV _{GES}	Gate to E	mitter Breakdown Voltage	I _{GES} = ±	$I_{GES} = \pm 2mA$		±12	±14	-	V
I _{CER}	Collector t	o Emitter Leakage Curren	OLIN		$T_C = 25^{\circ}C$	-	-	25	μA
			R _G = 1Ks See Fig.		T _C = 150°C	-	-	1	mA
I _{ECS}	Emitter to	Collector Leakage Curren		V, See	$T_C = 25^{\circ}C$	-	-	1	mA
			Fig. 11		$T_{\rm C} = 150^{\circ}{\rm C}$	-	_	40	m 1
R_1					IC = 130 C	•		40	IIIA
· ·		te Resistance			1C = 130 C	-	75	-	Ω
R ₂	Gate to E	mitter Resistance			1C = 130 C	- 10K	75	- 30K	mA Ω Ω
R ₂		mitter Resistance				-	75	-	Ω
R ₂	Gate to Er	mitter Resistance	ge $I_C = 10A$ $V_{GE} = 4.$		T _C = 25°C, See Fig. 4	-	1.17	-	Ω
R ₂	Gate to Er Characte Collector t	mitter Resistance	$V_{GE} = 4.0$	0V ,	T _C = 25°C,	-	-	- 30K	Ω Ω V
R_2 On State $V_{CE(SAT)}$ $V_{CE(SAT)}$	Gate to Er Characte Collector t	eristics to Emitter Saturation Voltage to Emitter Saturation Voltage	$V_{GE} = 4.0$ ge $I_C = 15A$	0V ,	T _C = 25°C, See Fig. 4	- 10K	1.17	30K	Ω Ω V
R ₂ On State V _{CE(SAT)} V _{CE(SAT)}	Collector to	ristics to Emitter Saturation Voltage to Emitter Saturation Voltage to Emitter Saturation Voltage	$V_{GE} = 4.0$ ge $I_C = 15A$	0V , 5V , V _{CE} =	$T_C = 25^{\circ}C$, See Fig. 4 $T_C = 150^{\circ}C$	- 10K	1.17	30K	Ω Ω V
R ₂ On State VCE(SAT) VCE(SAT)	Characte Collector t Collector t Characte Gate Cha	ristics to Emitter Saturation Voltage to Emitter Saturation Voltage to Emitter Saturation Voltage	$V_{GE} = 4.1$ ge $I_{C} = 15A$ $V_{GE} = 4.1$ $I_{C} = 10A$ $V_{GE} = 5$ $I_{C} = 1.0n$, V _{CE} = /, See	$T_{C} = 25^{\circ}\text{C},$ See Fig. 4 $T_{C} = 150^{\circ}\text{C}$ = 12V, Fig. 14 $T_{C} = 25^{\circ}\text{C}$	- 10K	1.17	30K	Ω Ω V
$\begin{array}{c} R_2 \\ \hline \text{On State} \\ \hline V_{\text{CE(SAT)}} \\ \hline V_{\text{CE(SAT)}} \\ \hline \\ \hline \text{Oynamic} \\ \hline Q_{\text{G(ON)}} \\ \end{array}$	Characte Collector t Collector t Characte Gate Characte Gate to E	ristics to Emitter Saturation Voltage to Emitter Saturation Voltage eristics rge mitter Threshold Voltage	$\begin{array}{c} V_{GE} = 4.\\ V_{GE} = 4.\\ V_{GE} = 4.\\ V_{GE} = 4.\\ V_{GE} = 5.\\ V_{CE} = 5.$	0V , , , V _{CE} = /, See nA, GE, 10	$T_{C} = 25^{\circ}\text{C}$, See Fig. 4 $T_{C} = 150^{\circ}\text{C}$ = 12V, Fig. 14 $T_{C} = 25^{\circ}\text{C}$ $T_{C} = 150^{\circ}\text{C}$	- 10K	1.17	30K 1.60 1.80	Ω Ω V V V V V V V V V V V V V V V V V V
R_2 On State $V_{CE(SAT)}$ $V_{CE(SAT)}$ Oynamic $Q_{G(ON)}$	Characte Collector t Collector t Characte Gate Characte Gate to E	mitter Resistance Pristics To Emitter Saturation Voltage To Emitter Saturation Voltage Pristics Trige	$V_{GE} = 4.1$ ge $I_{C} = 15A$ $V_{GE} = 4.1$ $I_{C} = 10A$ $V_{GE} = 5V$ $I_{C} = 1.0m$ $V_{CE} = V_{C}$	0V , , , V _{CE} = /, See nA, GE, 10	$T_{C} = 25^{\circ}\text{C},$ See Fig. 4 $T_{C} = 150^{\circ}\text{C}$ = 12V, Fig. 14 $T_{C} = 25^{\circ}\text{C}$	- 10K	1.17	30K 1.60 1.80	Ω Ω V V V V V V V V V V V V V V V V V V
$\begin{array}{c} R_2 \\ \hline \text{On State} \\ \hline V_{\text{CE(SAT)}} \\ \hline V_{\text{CE(SAT)}} \\ \hline \\ \hline V_{\text{GE(SAT)}} \\ \hline \\ \hline V_{\text{GE(TH)}} \\ \hline \\ \hline \\ \hline \\ \hline V_{\text{GEP}} \\ \hline \end{array}$	Characte Collector t Collector t Characte Gate Characte Gate to E	ristics to Emitter Saturation Voltage to Emitter Saturation Voltage eristics trige mitter Threshold Voltage	$\begin{array}{c} V_{GE} = 4.\\ V_{GE} = 4.\\ V_{GE} = 4.\\ V_{GE} = 4.\\ V_{GE} = 5.\\ V_{CE} = 5.$	0V , , , V _{CE} = /, See nA, GE, 10	$T_{C} = 25^{\circ}\text{C}$, See Fig. 4 $T_{C} = 150^{\circ}\text{C}$ = 12V, Fig. 14 $T_{C} = 25^{\circ}\text{C}$ $T_{C} = 150^{\circ}\text{C}$	- 10K	1.17 1.50	30K 1.60 1.80	Ω Ω V V V V V V V V V V V V V V V V V V
R ₂ On State VCE(SAT) VCE(SAT) Oynamic QG(ON) VGE(TH) VGEP	Characte Collector t Collector t Characte Gate Cha Gate to E Gate to E	ristics to Emitter Saturation Voltage to Emitter Saturation Voltage eristics trige mitter Threshold Voltage	$\begin{aligned} & V_{GE} = 4.\\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ &$	0V , , V _{CE} = /, See nA, GE, 10	$T_{C} = 25^{\circ}\text{C}$, See Fig. 4 $T_{C} = 150^{\circ}\text{C}$ $12V$, Fig. 14 $T_{C} = 25^{\circ}\text{C}$ $T_{C} = 150^{\circ}\text{C}$ $V_{CE} = 12V$	- 10K	1.17 1.50	30K 1.60 1.80	Ω Ω V V N C V V V V V V V V V V V V V V V V
$\begin{array}{c} R_2 \\ \hline \text{On State} \\ \hline V_{\text{CE(SAT)}} \\ \hline V_{\text{CE(SAT)}} \\ \hline \\ \hline \text{Oynamic} \\ \hline Q_{\text{G(ON)}} \\ \hline \\ V_{\text{GE(TH)}} \\ \hline \\ \hline \end{array}$	Characte Collector t Collector t Collector t Characte Gate Cha Gate to E Gate to E Charact Current Ti	ristics to Emitter Saturation Voltage ristics to Emitter Saturation Voltage ristics rge mitter Threshold Voltage mitter Plateau Voltage	$\begin{array}{c c} V_{GE} = 4.\\ V_{GE} = 4.\\ \end{array}$ $\begin{array}{c c} I_{C} = 15A\\ V_{GE} = 4.\\ \end{array}$ $\begin{array}{c c} I_{C} = 10A\\ V_{GE} = 5\\ \end{array}$ $\begin{array}{c c} I_{C} = 1.0n\\ V_{CE} = V_{C}\\ See Fig.\\ \end{array}$ $\begin{array}{c c} I_{C} = 10A\\ \end{array}$	0V , , V _{CE} = //, See InA, GE, 10 ,	T_C = 25°C, See Fig. 4 T_C = 150°C 12V, Fig. 14 T_C = 25°C T_C = 150°C V_{CE} = 12V	- 10K	1.17 1.50 32 - - 3.0	- 30K 1.60 1.80	Ω Ω V V V V V V V V V V V V V V V V V V
R ₂ On State VCE(SAT) VCE(SAT) Oynamic QG(ON) VGE(TH) VGEP Switching t _{d(ON)R} t _{rR}	Characte Collector t Collector t Collector t Collector t Characte Gate Cha Gate to E Gate to E Current Ti Current R	mitter Resistance ristics to Emitter Saturation Voltate to Emitter Saturation Voltate to Emitter Saturation Voltate ristics rge mitter Threshold Voltage mitter Plateau Voltage teristics teristics	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	0V , V _{CE} = /, See /, See /nA, GE, 10 , , , , , , , , , , , , , , , , , , ,	T_C = 25°C, See Fig. 4 T_C = 150°C 12V, Fig. 14 T_C = 25°C T_C = 150°C V_{CE} = 12V	- 10K	1.17 1.50 32 - - 3.0	- 30K 1.60 1.80	Ω Ω V V V V V V V V V V V V V V V V V V
R_2 On State $V_{CE(SAT)}$ $V_{CE(SAT)}$ Oynamic $Q_{G(ON)}$ $V_{GE(TH)}$ V_{GEP} Switching	Characte Collector t Collector t Collector t Collector t Characte Gate Cha Gate to E Gate to E Current Ti Current Ti Current Ti Current Ti	mitter Resistance ristics to Emitter Saturation Voltate to Emitter Saturation Voltate to Emitter Saturation Voltate ristics rge mitter Threshold Voltage mitter Plateau Voltage teristics urn-On Delay Time-Resistiise Time-Resistive	$\begin{array}{c c} V_{GE} = 4.\\ V_{GE} = 4.\\ \end{array}$ $\begin{array}{c c} I_{C} = 15A \\ V_{GE} = 4.\\ \end{array}$ $\begin{array}{c c} I_{C} = 10A \\ V_{GE} = 5\\ \end{array}$ $\begin{array}{c c} I_{C} = 1.0n \\ V_{CE} = V_{C} \\ See Fig. \\ \end{array}$ $\begin{array}{c c} I_{C} = 10A \\ \end{array}$ $\begin{array}{c c} V_{CE} = 14 \\ V_{GE} = 5\\ \end{array}$ $\begin{array}{c c} V_{CE} = 14 \\ V_{CE} = 5\\ \end{array}$	0V , V _{CE} = /, See /, See /, R _C = C, See //, R _G = C, See //, R _G = C, R _C = C, R _C = R _C //, R _C //, R _C = R _C //, R _C ///, R _C ///, R _C ///, R _C ////, R _C /////, R _C ///////, R _C ////////////////////////////////////	T_C = 25°C, See Fig. 4 T_C = 150°C T_C = 12V T_C = 150°C T_C = 150°C T_C = 150°C	- 10K 1.3 0.75	32 - - 3.0 0.7 2.1	- 30K 1.60 1.80	Ω Ω V V V V V V V V V V V V V V V V V V

TO-263, TO-220, TO-262

0.6

°C/W

Thermal Characteristics

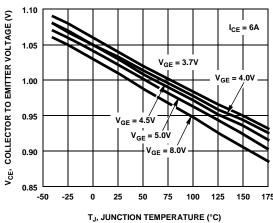
Thermal Resistance Junction-Case

 $R_{\underline{\theta JC}}$

Typical Characteristics INDUCTIVE SWITCHING CURRENT (A) $R_G = 1K\Omega$, $V_{GE} = 5V$, $V_{dd} = 14V$ 40 35 30 T_J = 25°C 25 20 15 T_J = 150°C 10 5 alid for V_{clamp} Voltages of <390V 0 t_{CLP}, TIME IN CLAMP (μS) Figure 1. Self Clamped Inductive Switching **Current vs Time in Clamp**

45 INDUCTIVE SWITCHING CURRENT (A) $R_G = 1K\Omega$, $V_{GE} = 5V$, $V_{dd} = 14V$ 40 35 30 25 20 $T_J = 25^{\circ}C$ 15 10 SCIS, 5 SCIS Curves valid for V_{clamp} Voltages of <390V 0 L, INDUCTANCE (mHy)

Figure 2. Self Clamped Inductive Switching Current vs Inductance



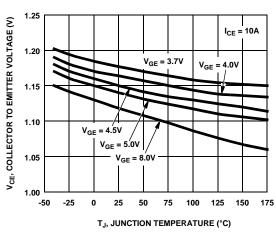
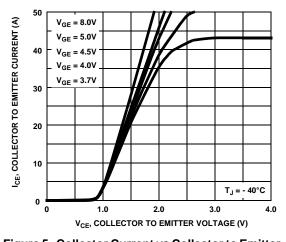


Figure 3. Collector to Emitter On-State Voltage vs Junction Temperature

Figure 4.Collector to Emitter On-State Voltage vs Junction Temperature



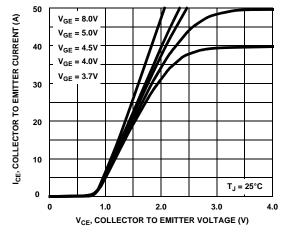


Figure 5. Collector Current vs Collector to Emitter On-State Voltage

Figure 6. Collector Current vs Collector to Emitter On-State Voltage

Typical Characteristics (Continued) V_{GE} = 8.0V I_{CE}, COLLECTOR TO EMITTER CURRENT (A) V_{GE} = 5.0V $V_{GF} = 4.5V$ $V_{GE} = 4.0V$ $V_{GE} = 3.7V$ 30 20 10 $T_J = 175^{\circ}C$ V_{CE}, COLLECTOR TO EMITTER VOLTAGE (V) Figure 7. Collector to Emitter On-State Voltage vs **Collector Current** 50 V_{GE} = 4.0V 40 30

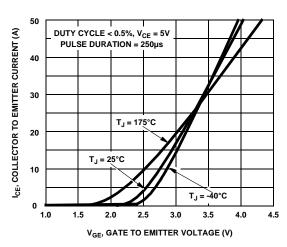
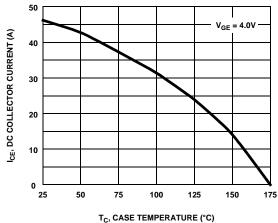


Figure 8. Transfer Characteristics



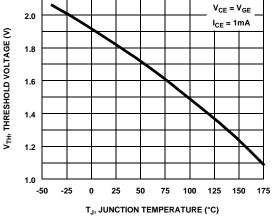
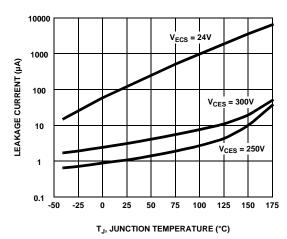


Figure 9. DC Collector Current vs Case Temperature

Figure 10. Threshold Voltage vs Junction Temperature



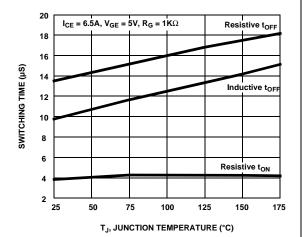
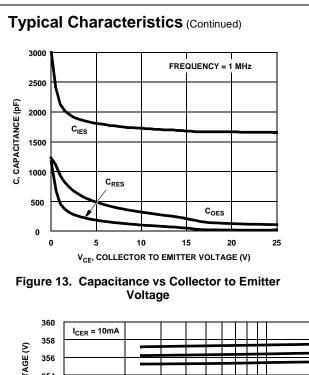


Figure 11. Leakage Current vs Junction Temperature

Figure 12. Switching Time vs Junction Temperature



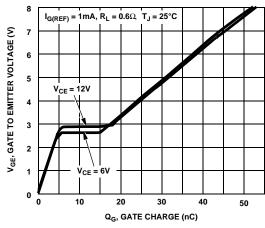
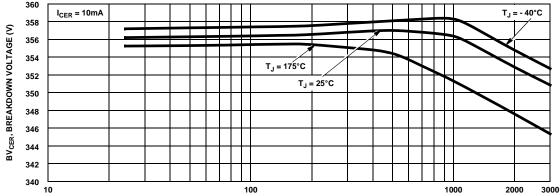


Figure 14. Gate Charge



 R_G , SERIES GATE RESISTANCE ($k\Omega$)

Figure 15. Breakdown Voltage vs Series Gate Resistance

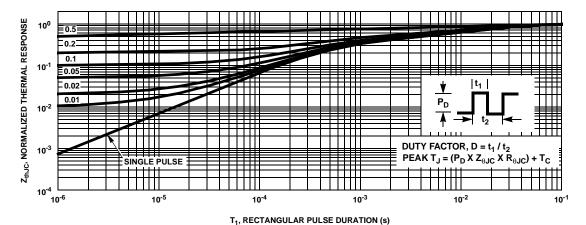
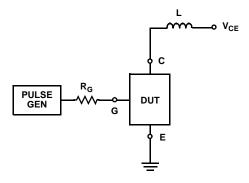


Figure 16. IGBT Normalized Transient Thermal Impedance, Junction to Case

Test Circuits and Waveforms



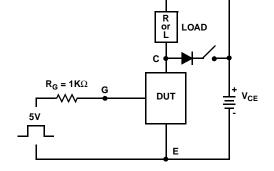


Figure 17. Inductive Switching Test Circuit

Figure 18. t_{ON} and t_{OFF} Switching Test Circuit

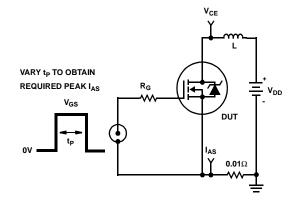


Figure 19. Energy Test Circuit

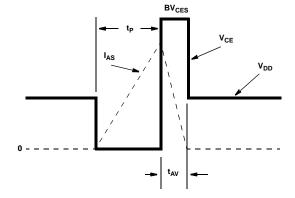
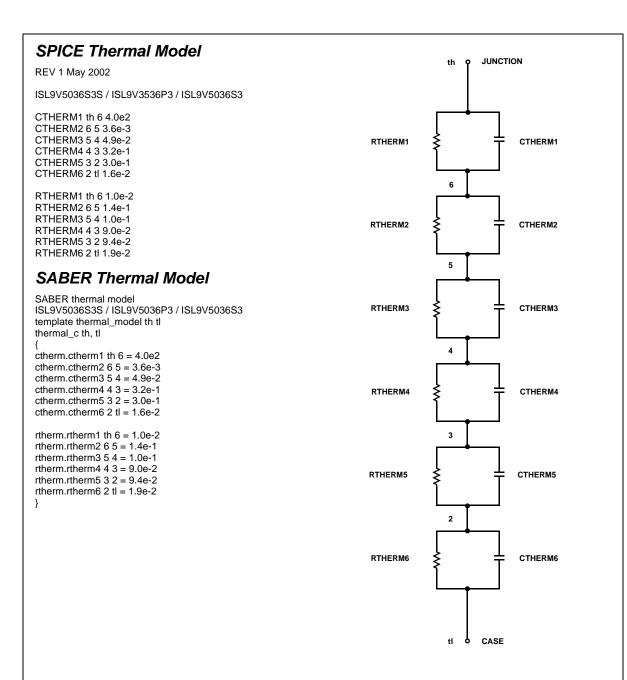


Figure 20. Energy Waveforms



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